## SIMPLE LED DRIVER FOR MR16 AND AR111 APPLICATIONS

Check for Samples：TPS92560

## FEATURES

－Controlled peak input current to prevent over－ stressing of the electronic transformer
－Allows either step－up or step－up／down operation
－Compatible to generic electronic transformers
－Compatible to magnetic transformers and DC power supplies
－Integrated active low－side input rectifiers
－Compact and simple circuit
－$>85 \%$ efficiency（12VDC input）
－Power factor＞ 0.9 （full load with AC input）
－Hysteretic control scheme
－Output Over－Voltage Protection
－Over－temperature Shutdown
－10－pin mini SOIC package with exposed pad

## APPLICATIONS

－MR16／AR111 LED lamps
－Lighting system using electronic transformer
－General lighting systems that require a boost／

## SEPIC LED driver

## DESCRIPTION

The TPS92560 is a simple LED driver designed to drive high power LEDs by drawing constant current from the power source．The device is ideal for MR16 and AR111 applications which need good compatibility to DC and AC voltages and electronic transformers．The hysteretic control scheme does not need control loop compensation while providing the benefits of fast transient response and high power factor．The patent pending feedback control method allows the output power to be determined by the number of LED used without component change．The TPS92560 supports both boost and SEPIC configurations for the use of different LED modules．

## TYPICAL APPLICATION



Typical application circuit of the TPS92560 using boost configuration

## TYPICAL APPLICATION (Continue)



Typical Application Circuit of the TPS92560 using SEPIC configuration

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## BLOCK DIAGRAM

TPS92560


SVA-30207403

## ORDERING INFORMATION

| ORDER NUMBER | PACKAGE TYPE | NSC PACKAGE DRAWING | SUPPLIED AS |
| :---: | :---: | :---: | :---: |
| TPS92560DGQ | 10L MINI SOIC EXP PAD | MUC10A | 1000 Units on Tape and Reel |
|  |  |  | 4500 Units on Tape and Reel |



SVA-30207405

## TERMINAL FUNCTIONS

| PIN |  | DESCRIPTION | APPLICATION INFORMATION |
| :---: | :---: | :---: | :---: |
| NO. | NAME |  |  |
| 1 | GATE | Gate driver output pin | Connect to the Gate terminal of the low-side N-channel Power FET |
| 2 | SRC | Gate driver return | Connect to the Source terminal of the low-side N-channel Power FET |
| 3 | VCC | VCC regulator output | Connect $0.47 \mu \mathrm{~F}$ decoupling cap from this pin to SRC pin |
| 4 | SEN | Current sense pin | Kelvin-sense current sensing input. Should connect to the current sensing resistor, $\mathrm{R}_{\text {SEN }}$. |
| 5 | GND | Analog ground | Reference point for current sensing. |
| 6 | ADJ | LED current adjust pin | Connect to resistor divider from LED top voltage rail to set LED current |
| 7 | VP | Power supply of the IC | Connect it to the LED top voltage rail (for boost) or Connect it through a diode from LED top voltage rail (for SEPIC) |
| 8 | AC2 | Power return terminal | Connect to AC or DC input terminal |
| 9 | PGND | Power ground | Connect to system ground plane |
| 10 | AC1 | Power return terminal | Connect to AC or DC input terminal |
|  | PowerPAD | Thermal DAP | Connect to system ground plane for heat dissipation |

## ABSOLUTE MAXIMUM RATINGS ${ }^{(1)}$

If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

|  | UNIT |  |
| :--- | :---: | :---: |
| SRC, SEN, ADJ | VALUE | -0.3 to 5 |
|  | AC1, AC2 | -1 to 45 |
|  | VP | -0.3 to 45 |
| VCC | -0.3 to 12 | V |
|  | Rating | Human Body Model ${ }^{(2)}$ |
| $T_{J}$ | Storage Temperature | -65 to +150 |

(1) Absolute Maximum Ratings are limits which damage to the device may occur. Operating ratings are conditions under which operation of the device is intended to be functional. For specified specifications and test conditions, see the electrical characteristics.
(2) The human body model is a 100 pF capacitor discharged through a $1.5 \mathrm{k} \Omega$ resistor into each pin.

## RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

|  |  | MIN | NOM | MAX |
| :--- | ---: | ---: | ---: | :---: |
| VP | Supply voltage range | 6.5 | 42 | UNIT |
| $\mathrm{T}_{\mathrm{J}}$ | Junction temperature range | -40 | 125 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}{ }^{(1)}$ | Thermal resistance, Junction to Ambient, 0 LFPM Air Flow | 48 |  |  |
| $\theta_{\text {JC }}{ }^{(1)}$ | Thermal resistance, Junction to Case | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |

(1) $\theta_{\mathrm{JA}}$ and $\theta_{\mathrm{Jc}}$ measurements are performed on JEDEC boards in accordance with JESD 51-5 and JESD 51-7

## ELECTRICAL CHARACTERISTICS

Specification with standard type are for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ only; limits in boldface type apply over the full Operating Junction Temperature ( $\mathrm{T}_{\mathrm{j}}$ ) range. Minimum and Maximum are specified through test, design or statistical correlation. Typical values represent the most likely parametric norm at $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$, and are provided for reference purposes only. Unless otherwise stated the following conditions apply: $\mathrm{V}_{\mathrm{VP}}=12 \mathrm{~V}$

|  | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SUPPLY |  |  |  |  |  |  |
| IIN | $\mathrm{V}_{\text {IN }}$ Operating current | $6.5 \mathrm{~V}<\mathrm{V}_{\mathrm{VP}}<42 \mathrm{~V}$ | 0.7 | 1.4 | 1.95 | mA |
| VCC REGULATOR |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\text {CC }}$ Regulated Voltage ${ }^{(1)}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{CC}} \leq 10 \mathrm{~mA}, \mathrm{C}_{\mathrm{VCC}}=0.47 \mu \mathrm{~F} \\ & 12 \mathrm{~V}<\mathrm{V}_{\mathrm{VP}}<42 \mathrm{~V} \end{aligned}$ | 7.82 | 8.45 | 9.08 | V |
|  |  | $\mathrm{I}_{\mathrm{CC}}=10 \mathrm{~mA}, \mathrm{C}_{\mathrm{VCC}}=0.47 \mu \mathrm{~F} \mathrm{~V}_{\mathrm{VP}}=6.5 \mathrm{~V}$ | 5.22 | 5.8 | 6.18 |  |
|  |  | $\mathrm{I}_{\mathrm{CC}}=0 \mathrm{~mA}, \mathrm{C}_{\mathrm{VCC}}=0.47 \mu \mathrm{~F} \mathrm{~V} \mathrm{VP}=2 \mathrm{~V}$ | 1.96 | 2.0 |  |  |
| $\mathrm{I}_{\text {CC-LIM }}$ | $\mathrm{V}_{\mathrm{CC}}$ Current Limit | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V} 6.5 \mathrm{~V}<\mathrm{V}_{\mathrm{VP}}<42 \mathrm{~V}$ | 21 | 30 | 39 | mA |
| V ${ }_{\text {CC-UVLO-UPTH }}$ | $V_{\text {CC }}$ UVLO Upper Threshold |  | 5.0 | 5.38 | 5.76 | V |
| $\mathrm{V}_{\text {CC-UVLO-LOTH }}$ | $\mathrm{V}_{\text {CC }}$ UVLO Lower Threshold |  | 4.63 | 4.98 | 5.33 | V |
| $\mathrm{V}_{\text {CC-UVLO-HYS }}$ | $V_{C C}$ UVLO Hysteresis |  | 190 | 400 | 640 | mV |
| MOSFET GATE DRIVER |  |  |  |  |  |  |
| $\mathrm{V}_{\text {GATE-HIGH }}$ | Gate Driver Output High | w.r.t. SRC <br> Sinking 100 mA from GATE Force VCC $=8.5 \mathrm{~V}$ | 7.61 | 8.1 | 8.5 | V |
| $\mathrm{V}_{\text {GATE-Low }}$ | Gate Driver Output Low | w.r.t. SRC <br> Sourcing 100 mA to GATE | 100 | 180 | 290 | mV |
| $\mathrm{t}_{\text {RISE }}$ | $V_{\text {GATE }}$ Rise Time | $\mathrm{C}_{\text {GATE }}=1 \mathrm{nF}$ across GATE and SRC |  | 22 |  | ns |
| $\mathrm{t}_{\text {FALL }}$ | $\mathrm{V}_{\text {GATE }}$ Fall Time | $\mathrm{C}_{\text {GATE }}=1 \mathrm{nF}$ across GATE and SRC |  | 14 |  | ns |
| trise-PG-DELAY | $\mathrm{V}_{\text {GATE }}$ Low to High Propagation Delay | $\mathrm{C}_{\text {GATE }}=1 \mathrm{nF}$ across GATE and SRC |  | 68 |  | ns |
| $\mathrm{t}_{\text {FALL-PG-DELAY }}$ | $\mathrm{V}_{\text {GATE }}$ High to Low Propagation Delay | $\mathrm{C}_{\text {GATE }}=1 \mathrm{nF}$ across GATE and SRC |  | 84 |  | ns |
| CURRENT SOURCE AT ADJ PIN |  |  |  |  |  |  |
| $\mathrm{I}_{\text {ADJ-STARTUP }}$ | Output Current of ADJ pin at Startup | $\mathrm{V}_{\text {ADJ }}=0 \mathrm{~V}$ | 16 | 20 | 24 | $\mu \mathrm{A}$ |
| IADJ-ELEC-XFR | Output Current of ADJ pin for Electronic Transformers | An Electronic Transformer is Detected | 8 | 11.5 | 15 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {ADJ-MAG-XFR }}$ | Output Current of ADJ pin for Inductive Transformers | An Magnetic Transformer is Detected | 7 | 9.5 | 12 | $\mu \mathrm{A}$ |
| CURRENT SENSE COMPARATOR |  |  |  |  |  |  |
| $\mathrm{V}_{\text {SEN-UPPER-TH }}$ | $\mathrm{V}_{\text {SEN }}$ Upper Threshold Over $\mathrm{V}_{\text {ADJ }}$ | $\mathrm{V}_{\mathrm{SEN}}-\mathrm{V}_{\mathrm{ADJ}}, \mathrm{~V}_{\mathrm{ADJ}}=0.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{GATE}} \text { at falling }$ edge | 8.9 | 14.9 | 20.9 | mV |
| $\mathrm{V}_{\text {SEN-LOWER-TH }}$ | V ${ }_{\text {SEN }}$ Lower Threshold Over VADJ | $\begin{aligned} & \mathrm{V}_{\text {SEN }}-\mathrm{V}_{\text {ADJ }}, \mathrm{V}_{\text {ADJ }}=0.2 \mathrm{~V} \mathrm{~V}_{\text {GATE }} \text { at rising } \\ & \text { edge } \end{aligned}$ | -20.6 | -14.9 | -8.8 | mV |
| $\mathrm{V}_{\text {SEN-HYS }}$ | $\mathrm{V}_{\text {SEN }}$ Hysteresis | ( $\mathrm{V}_{\text {SEN-UPPER-TH }}-\mathrm{V}_{\text {SEN-LOWER-TH }}$ ) | 22.5 | 29.8 | 37.5 | mV |
| $\mathrm{V}_{\text {SEN-OFFSET }}$ | $\mathrm{V}_{\text {SEN }}$ Offset w.r.t. $\mathrm{V}_{\text {ADJ }}$ | $\left(\mathrm{V}_{\text {SEN-UPPER-TH }}+\mathrm{V}_{\text {SEN-LOWER-TH }}\right) / 2$ | -3.5 | 0.02 | 3.5 | mV |
| ACTIVE low-side input rectifiers |  |  |  |  |  |  |
| $\mathrm{R}_{\text {ACn-ON }}$ | In resistance of AC1 and AC2 to GND | $\mathrm{I}_{\text {ACn }}=200 \mathrm{~mA}$ |  | 300 | 570 | $\mathrm{m} \Omega$ |

(1) $\mathrm{V}_{\mathrm{CC}}$ provides self bias for the internal gate drive and control circuits. Device thermal limitations limit external loading.

## ELECTRICAL CHARACTERISTICS (continued)

Specification with standard type are for $T_{A}=T_{J}=25^{\circ} \mathrm{C}$ only; limits in boldface type apply over the full Operating Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) range. Minimum and Maximum are specified through test, design or statistical correlation. Typical values represent the most likely parametric norm at $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$, and are provided for reference purposes only. Unless otherwise stated the following conditions apply: $\mathrm{V}_{\mathrm{VP}}=12 \mathrm{~V}$

| PARAMETER |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {ACn-ON-TH }}$ | Turn ON Voltage Threshold of AC1 and AC2 | $\mathrm{V}_{\mathrm{ACn}}$ Decreasing | 36 | 52 | 67 | mV |
| $\mathrm{V}_{\text {ACn-OFF-TH }}$ | Turn OFF Voltage Threshold of AC1 and AC2 | $\mathrm{V}_{\text {ACn }}$ Increasing | 77 | 90 | 104 | mV |
| $\mathrm{V}_{\text {ACn-TH-HYS }}$ | Hysteresis Voltage of AC1 and AC2 | $\mathrm{V}_{\text {ACn-OFF-TH }}-\mathrm{V}_{\text {ACn-ON-TH }}$ |  | 39 |  | mV |
| $\mathrm{I}_{\text {ACn-OFF }}$ | Off Current of AC1 and AC2 | $\mathrm{V}_{\text {ACn }}=45 \mathrm{~V}$ |  | 21 | 32 | $\mu \mathrm{A}$ |
| OUTPUT OVER-VOLTAGE-PROTECTION (OVP) |  |  |  |  |  |  |
| $\mathrm{V}_{\text {ADJJOVP-UPTH }}$ | Output Over-Voltage-Detection Upper Threshold | $\mathrm{V}_{\mathrm{ADJ}}$ Increasing, $\mathrm{V}_{\mathrm{GATE}}$ at falling edge | 0.353 | 0.384 | 0.415 | V |
| $\mathrm{V}_{\text {ADJ-OVP-LOTH }}$ | Output Over-Voltage-Detection Lower Threshold | $\mathrm{V}_{\mathrm{ADJ}}$ Decreasing, $\mathrm{V}_{\text {GATE }}$ at rising edge | 0.312 | 0.339 | 0.366 | V |
| $\mathrm{V}_{\text {ADJ-OVP-HYS }}$ | Output Over-Voltage-Detection Hysteresis | $\mathrm{V}_{\text {ADJ-OVP-UPTH }}-\mathrm{V}_{\text {ADJJ-OVP-LOTH }}$ | 25 | 46 | 67 | mV |
| THERMAL SHUTDOWN |  |  |  |  |  |  |
| $\mathrm{T}_{\text {SD }}$ | Thermal Shutdown Temperature | $\mathrm{T}_{\mathrm{J}}$ Rising |  | 165 |  | ${ }^{\circ} \mathrm{C}$ |
| TSD-HYS | Thermal Shutdown Temperature Hysteresis | $\mathrm{T}_{\mathrm{J}}$ Falling |  | 30 |  | ${ }^{\circ} \mathrm{C}$ |

TYPICAL CHARACTERISTICS
All curves taken for the boost circuit are with 500 mA nominal input current and 6 serial LEDs. All curves taken for the SEPIC circuit are with 500 mA nominal input current and 3 serial LEDs. $T_{A}=40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$, unless otherwise specified.


Figure 1.


Figure 3.
ACn Turn OFF Threshold vs. Temperature


Figure 5.


Figure 2.
VCC UVLO Falling Threshold vs. Temperature $\mathrm{V}_{\mathrm{vp}}=12 \mathrm{~V}$, GATE='Low'


Figure 4.
ACn Turn ON Threshold vs. Temperature


Figure 6.

## TYPICAL CHARACTERISTICS (continued)

All curves taken for the boost circuit are with 500 mA nominal input current and 6 serial LEDs. All curves taken for the SEPIC circuit are with 500 mA nominal input current and 3 serial LEDs. $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$, unless otherwise specified.


Figure 7.


Figure 9.
Efficiency (BOOST) vs. Temperature


Figure 11.


Figure 8.


Figure 10.


Figure 12.

## OVERVIEW

The TPS92560 is a simple hysteretic control switching LED driver for MR16 or AR111 lighting applications. The device accepts DC voltage, AC voltage and electronic transformer as an input power source. The compact application circuit can fit into a generic case of MR16 lamps easily. The hysteretic inductor current control scheme requires no small signal control loop compensation and maintains constant average input current to secure high compatibility to different kinds of input power source. The TPS92560 can be configured to either a step-up or step-up/down LED driver for the use of different number of LEDs. The patent pending current control mechanism allows the use of a single set of component and PCB layout for serving different output power requirements by changing the number of LEDs. The integrating of the active low-side input rectifiers reduces the power loss for voltage rectification and saves two external diodes of a generic bridge rectifier to aim for a simple end application circuit. When the driver is used with an AC voltage source or electronic transformer, the current regulation level increases accordingly to maintain an output current close to the level that when it is used with a DC voltage source. With the output over-voltage protection and over-temperature shutdown functions, the TPS92560 is specifically suitable for the applications that are space limited and need wide acceptance to different power sources.

## VCC REGULATOR

The VCC pin is the output of the internal linear regulator for providing an 8.45 V typical supply voltage to the MOSFET driver and internal circuits. The output current of the VCC pin is limited to 30 mA typical. A low ESR ceramic capacitor of $0.47 \mu \mathrm{~F}$ or higher capacitance should be connected across the VCC and SRC pins to supply transient current to the MOSFET driver.

## MOSFET DRIVER

The GATE pin is the output of the gate driver which referenced to the SRC pin. The gate driver is powered directly by the VCC regulator which the maximum gate driving current is limited to 30 mA typical. To prevent hitting the VCC current limit, it is suggested to use a low gate charge MOSFET when high switching frequency is needed.

## THE ADJ PIN

The voltage on the ADJ pin determines the reference voltage for the input current regulation. Typically, the ADJ pin voltage is divided from the output voltage of the circuit by a voltage divider, thus the average input current is adjusted with respect to the number of LEDs used. The voltage of the ADJ pin determines the input current following the expression:

$$
\begin{equation*}
I_{\operatorname{IN}(\text { nom })}=\frac{V_{V P}}{R_{S E N}} \times \frac{R_{A D J 2}}{R_{A D J 1}+R_{A D J 2}} \tag{1}
\end{equation*}
$$

## Output Over-Voltage-Protection

In the TPS92560, a function of output Over-Voltage Protection (OVP) is provided to prevent damaging of the circuit due to an open circuit of the LED. The OVP function is implemented to the ADJ pin. When the voltage of the ADJ pin exceeds 0.384 V typical, the OVP circuit disables the MOSFET driver and turns off the main switch to allow the output capacitor to discharge. As the voltage of the ADJ pin decreases to below 0.353 V typical, the MOSFET driver is enabled and the TPS92560 returns to normal operation. The triggering threshold of the output voltage is determined by the value of the resistors $R_{A D J 1}$ and $R_{A D J 2}$, which can be calculated using the following equation:

$$
\begin{equation*}
V_{V P} \times \frac{R_{A D J 2}}{R_{A D J 1}+R_{A D J 2}} \leq 0.384 V \tag{2}
\end{equation*}
$$

When defining the OVP threshold voltage, it is necessary to certain that the OVP threshold voltage does not exceed the rated voltage of the output rectifier and capacitor to avoid damaging of the circuit.

## THE AC1 AND AC2 PINS

The TPS92560 provides two internal active rectifiers for input voltage rectification. Each internal rectifier connects across the ACn pin to GND. These internal active rectifiers function as the low-side diode rectifiers of a generic bridge rectifier. The integrating of the active rectifiers helps in saving two external diodes of a bridge rectifier along with an improvement of power efficiency. For high power applications, for instance, 12W output power, external diode rectifiers can be added across the ACn pin to GND to reduce heat dissipation on the TPS92560.

## DETECTION OF POWER SOURCE



Figure 13. The inherent dead time of the output voltage of an electronic transformer
Both the voltages of a generic AC source $(50 / 60 \mathrm{~Hz}$ ) and an electronic transformer carry certain amount of dead time inherently, as shown in Figure 13. The existing of the dead time leads to a drop of the RMS input power to the driver circuit. In order to compensate the drop of the RMS input power, the ADJ pin sources current to the resistor, $\mathrm{R}_{\mathrm{ADJ} 2}$ to increase the reference voltage for the current regulation loop and in turn increase the RMS input power accordingly when an AC voltage source or electronic transformer is detected. The output current of the ADJ pin for an AC input voltage and electronic transformer are $9.5 \mu \mathrm{~A}$ and $11.5 \mu \mathrm{~A}$ typical respectively. Practically the amount of the power for compensating the dead time of the input power source differs case to case depending on the characteristics of the power source, the value of the $R_{A D J 1}$ and $R_{A D J 2}$ might need a fine adjustment in accordance to the characteristics of the power source. The additional output power for compensating the dead time of the power sources ( $\Delta \mathrm{P}_{\mathrm{LED}}$ ) are calculated using the following equations:
For $50 / 60 \mathrm{~Hz}$ AC power source:

$$
\begin{equation*}
\Delta \mathrm{P}_{\mathrm{LED}-50 / 60 \mathrm{~Hz}}=\mathrm{V}_{\mathrm{IN}} \times \frac{\mathrm{R}_{\mathrm{ADJ} 2} \times 9.5 \mu \mathrm{~A}}{\mathrm{R}_{\mathrm{SEN}}} \times \eta \tag{3}
\end{equation*}
$$

For electronic transformer:

$$
\begin{equation*}
\Delta \mathrm{P}_{\text {LED-ELECT-XFR }}=\mathrm{V}_{\mathrm{IN}} \times \frac{\mathrm{R}_{\text {ADJ2 }} \times 11.5 \mu \mathrm{~A}}{\mathrm{R}_{\text {SEN }}} \times \eta \tag{4}
\end{equation*}
$$

## CURRENT REGULATION

In the TPS92560, the input current regulation is attained by limiting the peak and valley of the inductor current. Practically the inductor current sensing is facilitated by detecting the voltage on the resistor, $\mathrm{R}_{\text {SEN }}$. Because the current flows through the $\mathrm{R}_{\text {SEN }}$ is a sum total of the currents of the main switch and LEDs, the voltage drop on the $\mathrm{R}_{\text {SEN }}$ reflects the current of the inductor that is identical to the input current to the LED driver circuit. Figure 14 shows the waveform of the inductor current ripple with the peak and valley values controlled.


SVA-30207404
Figure 14. Inductor Current Ripple in Steady State
The voltage of the ADJ pin is determined by the forward voltage of the LED and divided from the $\mathrm{V}_{\mathrm{Vp}}$ by a resistor divider. The equation for calculating the $\mathrm{V}_{\text {ADJ }}$ as shown in the following expression:

$$
\begin{equation*}
V_{A D J}=V_{V P} \times \frac{R_{A D J 2}}{R_{A D J 1}+R_{A D J 2}} \tag{5}
\end{equation*}
$$

In steady state, the voltage drop on the $R_{A D J 1}$ is identical to the forward voltage of the LED ( $\mathrm{V}_{\mathrm{LED}}$ ) and the voltage across the $R_{\text {ADJ } 2}$ is identical to the voltage across the $R_{\text {SEN }}$. The LED current, $\mathrm{I}_{\text {LED }}$ is then calculated following the equations:
In steady state:

$$
\begin{align*}
& V_{\text {LED }}=\mathrm{V}_{\text {RADJ1 }}  \tag{6}\\
& \mathrm{V}_{\text {SEN }}=\mathrm{V}_{\text {RADJ2 }}  \tag{7}\\
& \mathrm{I}_{\mathrm{IN}(\text { nom })}=\frac{\mathrm{V}_{\text {SEN }}}{\mathrm{R}_{\text {SEN }}} \tag{8}
\end{align*}
$$

Since

$$
\begin{equation*}
P_{\text {LED }}=P_{\text {IN }} \times \eta \quad \text { where } \eta \text { is the conversion efficiency } \tag{9}
\end{equation*}
$$

Thus,

$$
\begin{equation*}
V_{\text {LED }} \times I_{\text {LED }}=V_{V_{N}} \times I_{\operatorname{IN(nom)})} \times \eta \tag{10}
\end{equation*}
$$

Put the expressions (2) to (4) into (5):

$$
\begin{equation*}
I_{\text {LED }}=V_{I N} \times \frac{I_{A D J 2} \times R_{A D J 2}}{I_{A D J 1} \times R_{A D J 1} \times R_{S E N}} \times \eta \tag{11}
\end{equation*}
$$

Due to the high input impedance of the ADJ pin, the current flows into the ADJ pin can be neglected and thus $I_{\text {RADJ1 }}$ equals $I_{\text {RADJ2. }}$. The LED current is then calculated following the expressions below:

$$
\begin{equation*}
I_{\text {LED }}=V_{\mathbb{I N}} \times \frac{R_{\text {ADJ2 }}}{R_{\text {ADJ1 }} \times R_{\text {SEN }}} \times \eta \tag{12}
\end{equation*}
$$

Practically, the conversion efficiency of a boost circuit is almost a constant around $85 \%$. Being assumed that the efficiency term in the $\mathrm{I}_{\text {LED }}$ expression is a constant, the LED current depends solely on the magnitude of the input voltage, $\mathrm{V}_{\mathbb{I N}}$. Without changing a component, the output power of the typical application circuits of the TPS92560 is adjustable by using different number of LEDs.
The output power is calculated by following the expression:

$$
\begin{equation*}
P_{\text {LED }}=V_{\text {LED }} \times V_{\mathbb{I N}} \times \frac{R_{\text {ADJ2 }}}{R_{\text {ADJ1 }} \times R_{\text {SEN }}} \times \eta \tag{13}
\end{equation*}
$$

## SWITCHING FREQUENCY (Boost Configuration)

In the following sections, the equations and calculations are limited to the boost configuration only (i.e. the LED forward voltage higher than the input voltage), unless otherwise specified. The application information for the SEPIC and other circuit topologies are available in separate application notes and reference designs. In the boost configuration, including the propagation delay of the control circuit, the ON and OFF times of the main switch are calculated following the expressions:

$$
\begin{align*}
& \mathrm{t}_{\text {ON }}=\left\{\frac{\left|V_{\text {SEN-UPPER-TH }}\right| \times L}{R_{\text {SEN }} \times\left[\mathrm{V}_{\text {IN }}-\mathrm{V}_{\mathrm{D}}-\mathrm{I}_{\mathrm{IN(nom)})} \times\left(\mathrm{R}_{\mathrm{L}}+\mathrm{R}_{\text {DS(ON) }}+\mathrm{R}_{\text {SEN }}+\mathrm{R}_{\text {AC-FET }}\right)\right]}+\mathrm{t}_{\text {FALL-PG-DELAY }}\right\} \times 2  \tag{14}\\
& \mathrm{t}_{\text {OFF }}=\left\{\frac{\left|\mathrm{V}_{\text {SEN-Lower-TH }}\right| \times \mathrm{L}}{\mathrm{R}_{\text {SEN }} \times\left[\mathrm{V}_{\text {LED }}-\mathrm{V}_{\text {IN }}-2 \mathrm{~V}_{\mathrm{D}}-\mathrm{I}_{\text {IN(nom })} \times\left(\mathrm{R}_{\mathrm{L}}+\mathrm{R}_{\text {SEN }}+\mathrm{R}_{\text {AC-FET }}\right)\right]}+\mathrm{t}_{\text {RISE-PG-DELAY }}\right\} \times 2 \tag{15}
\end{align*}
$$

In the above equations, the $V_{D}$ is the forward voltage of $D_{3}, R_{L}$ is the $D C$ resistance of $L_{1}, R_{D S(O N)}$ is the $O N$ resistance of $Q_{1}$ and $R_{A C-F E T}$ is the turn $O N$ resistance of the internal active rectifier with respect to the typical application circuit diagram.
Practically the resistance of the $R_{L}, R_{D S(o n)}$ and $R_{A C-F E T}$ is in the order if serveral tenth of $m \Omega$, by assuming a 0.5 V diode forward voltage and the sum total of the $R_{L}, R_{D S(O N)}$ and $R_{A C-F E T}$ is close to $1 \Omega$, the on and off times of $Q_{1}$ can be approximated using the following equations:

$$
\begin{align*}
& \mathrm{t}_{\mathrm{ON}} \approx\left\{\frac{14.9 \mathrm{mV} \times \mathrm{L}}{\mathrm{R}_{\text {SEN }} \times\left[\mathrm{V}_{\mathrm{IN}}-0.5 \mathrm{~V}-\mathrm{I}_{\mathrm{IN}(\text { nom })} \times\left(1+\mathrm{R}_{\text {SEN }}\right)\right]}+84 \mathrm{~ns}\right\} \times 2  \tag{16}\\
& \mathrm{t}_{\text {OFF }} \approx\left\{\frac{14.9 \mathrm{mV} \times \mathrm{L}}{\mathrm{R}_{\mathrm{SEN}} \times\left[\mathrm{V}_{\mathrm{LED}}-\mathrm{V}_{\text {IN }}-1 \mathrm{~V}-\mathrm{I}_{\mathrm{IN}(\text { nom })} \times\left(1+\mathrm{R}_{\text {SEN }}\right)\right]}+68 \mathrm{~ns}\right\} \times 2 \tag{17}
\end{align*}
$$

With the switching on and OF times determined, the switching frequency can be calculated using the following equation:

$$
\begin{equation*}
f_{\mathrm{sw}}=\frac{1}{t_{\mathrm{ON}}+t_{\mathrm{OFF}}} \tag{18}
\end{equation*}
$$

Because of the using of hysteretic control scheme, the switching frequency of the TPS92560 in steady state is dependent on the input voltage, output voltage and inductance of the inductor. Generally a 1 MHz to 1.5 MHz switching frequency is suggested for applications using an electronic transformer as the power source.

## INDUCTOR SELECTION (Boost Configuration)

Because of the using of the hysteretic control scheme, the switching frequency of the TPS92560 in a boost configuration can be adjusted in accordance to the value of the inductor being used. Derived from the equations (12) and (13), the value of the inductor can be determined base on the desired switching frequence by using the following equation:

$$
\begin{equation*}
\mathrm{L}=\frac{\left(\frac{1}{f_{S W}}-304 n \mathrm{~ns}\right) \times \mathrm{R}_{\mathrm{SEN}}}{\left(\frac{1}{\mathrm{~V}_{\mathbb{I}}-0.5 \mathrm{~V}-\mathrm{I}_{\mathrm{IN}(\mathrm{nom})} \times\left(1+\mathrm{R}_{\mathrm{SEN}}\right)}+\frac{1}{\mathrm{~V}_{\mathrm{LED}}-\mathrm{V}_{\mathrm{IN}}-1 \mathrm{~V}-\mathrm{I}_{\mathrm{IN}(\text { nom })} \times\left(1+\mathrm{R}_{\mathrm{SEN}}\right)}\right) \times 29.8 \mathrm{mV}} \tag{19}
\end{equation*}
$$

When selecting the inductor, it is essential to ensure the peak inductor current does not exceed the the factory suggested saturation current of the inductor. The values of the peak and valley inductor current are calculated using the following equations:
Peak inductor current:

$$
\begin{equation*}
I_{L \text { (peak })}=\frac{\left[V_{I_{N}}-V_{D}-I_{I_{N(n o m)}} \times\left(R_{L}+R_{D S(O N)}+R_{S E N}+R_{A C-F E T)}\right] \times t_{\text {ON }}\right.}{2 L}+I_{I N(\text { nom })} \tag{20}
\end{equation*}
$$

Valley inductor current:

$$
\begin{equation*}
I_{L \text { (valley })}=I_{I N(\text { nom })}-\frac{\left[V_{L E D}-V_{I N}-2 V_{D}-I_{I N(n o m)} \times\left(R_{L}+R_{S E N}+R_{A C-F E T}\right)\right] \times t_{\text {OFF }}}{2 L} \tag{21}
\end{equation*}
$$

Assume the total resistance of the $R_{L}, R_{D S(o n)}$ and $R_{A C-F E T}$ is $1 \Omega$ and the diode drop, $V_{D}$ equal to 1 V , the peak and valley currents of the inductor can be approximated using the following equations:

$$
\begin{align*}
& \mathrm{I}_{\mathrm{L} \text { (peak) }} \approx \frac{\left[\mathrm{V}_{\mathbb{N}}-0.5 \mathrm{~V}-\mathrm{I}_{\mathrm{IN}(\text { nom })} \times\left(1+\mathrm{R}_{\text {SEN }}\right)\right] \times \mathrm{t}_{\mathrm{ON}}}{2 \mathrm{~L}}+\mathrm{I}_{\mathrm{IN} \text { (nom) }}  \tag{22}\\
& \mathrm{I}_{\mathrm{L} \text { (valley) }} \approx \mathrm{I}_{\mathrm{IN}_{\mathrm{N} \text { (nom) }}-} \frac{\left[\mathrm{V}_{\text {LED }}-\mathrm{V}_{\text {IN }}-1 \mathrm{~V}-\mathrm{I}_{\mathrm{IN(nom)}} \times\left(1+\mathrm{R}_{\text {SEN }}\right)\right] \times \mathrm{t}_{\text {OFF }}}{2 \mathrm{~L}} \tag{23}
\end{align*}
$$

In order not to saturate the inductor, an inductor with a factory guranteed saturation current (ISAT) $20 \%$ higher than the $I_{\text {(peak) }}$ is suggested. Thus the $I_{\text {SAT }}$ of the inductor should fulfill the following requirement:
$I_{\text {SAT }} \geq I_{\text {L(peak) }} \times 1.2$

## THERMAL SHUTDOWN

The TPS92560 includes a thermal shutdown circuitry that ceases the operation of the device to avoid permanent damage. The threshold for thermal shutdown is $165^{\circ} \mathrm{C}$ with a $30^{\circ} \mathrm{C}$ hysteresis typical. During thermal shutdown the VCC regulator is disabled and the MOSFET is turned off.

## INPUT SURGE VOLTAGE PROTECTION

When use with an electronic transformer, the surge voltage across the input terminals can be sufficiently high to damage the TPS92560 depending on the charactistics of the electronic transformer. To against potential damaging due to the input surge voltage, a 36 V zener diode can be connected across the input bridge rectifier as shown in Figure 15.


Figure 15. Input surge voltage protection using an external zener diode

## EXAMPLE APPLICATION CIRCUITS

In the applications that need true regulation of the LED current, the intrinsic input current control loop can be changed to monitor the LED current by adding an external LED current sensing circuit. Figure 16 and Figure 19 show the example circuits for true LED current regulation in boost and SEPIC configurations respectively. In the circuits, the $U_{3}$ (TL431) maintains a constant 2.5 V voltage drop on the resistors, $\mathrm{R}_{3}$ and $\mathrm{R}_{7}$. Because the $\mathrm{U}_{2}$ (TL431) maintains a constant voltage drop on the $\mathrm{R}_{3}$, the power dissipation on the output current sensing resistor, $\mathrm{R}_{7}$ can be minimized by setting a low voltage drop on the $\mathrm{R}_{7}$. Because the change of the current flowing through the $R_{7}$ reflects in the change of the cathode current of $U_{3}$ and eventually adjusts the ADJ pin voltage of the TPS92560, the LED current is regulated independent of the change of the input voltage.

## Boost Application Circuit with LED Current Regulation

The specifications of the boost application circuit in Figure 16 are as listed below:

- Objective input voltage: 3VDC to $18 \mathrm{VDC} / 12 \mathrm{VAC}(50 \mathrm{~Hz}$ or 60 Hz$)$ / Generic MR16 electronic transformer
- LED forward voltage: 20VDC typical
- Output current: 300mA typical (@12VDC input)
- Output power: 6W typical (@12VDC input)


Figure 16. Using the TPS92560 in SEPIC configuration with LED current regulation

## Typical Characteristics of the Boost Example Circuit in Figure 16

All curves taken at $\mathrm{V}_{\mathbb{I N}}=3 \mathrm{~V}$ to 18 VDC in boost configuration, with 300 mA nominal output current, 6 serial LEDs. $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.


Figure 17.


Figure 18.

TPS92560
www.ti.com

## SEPIC Application Circuit with LED Current Regulation

The specifications of the SEPIC application circuit in Figure 16 are as listed below:

- Objective input voltage: 3VDC to $18 \mathrm{VDC} / 12 \mathrm{VAC}(50 \mathrm{~Hz}$ or 60 Hz$)$ / Generic MR16 electronic transformer
- LED forward voltage: 13VDC typical
- Output current: 300mA typical (@12VDC input)
- Output power: 4W typical (@12VDC input)


Figure 19. Using the TPS92560 in SEPIC configuration with LED current regulation

## Typical Characteristics of the SEPIC Example Circuit in Figure 19

All curves taken at $\mathrm{V}_{\mathbb{I N}}=3 \mathrm{~V}$ to 18 VDC in SEPIC configuration, with 300 mA nominal output current, 4 serial LEDs. $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.


Figure 20.


Figure 21.

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead/Ball Finish | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TPS92560DGQ/NOPB | ACTIVE | MSOP- <br> PowerPAD | DGQ | 10 | 1000 | $\begin{aligned} & \text { Green (RoHS } \\ & \text { \& no Sb/Br) } \end{aligned}$ | CU SN | Level-3-260C-168 HR | -40 to 125 | SN3B | Samples |
| TPS92560DGQR/NOPB | ACTIVE | MSOP- <br> PowerPAD | DGQ | 10 | 3500 | Green (RoHS \& no Sb/Br) | CU SN | Level-3-260C-168 HR | -40 to 125 | SN3B | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details
TBD: The Pb-Free/Green conversion plan has not been defined
Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb -Free (RoHS compatible) as defined above.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

```
勝 特 力 材 料 886-3-5753170
胜特力电子(上海) 86-21-34970699
胜特力电子(深圳) 86-755-83298787
    Http://www. 100y. com. tw
```


## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries（TI）reserve the right to make corrections，enhancements，improvements and other changes to its semiconductor products and services per JESD46，latest issue，and to discontinue any product or service per JESD48，latest issue．Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete．All semiconductor products（also referred to herein as＂components＂）are sold subject to Tl＇s terms and conditions of sale supplied at the time of order acknowledgment．
TI warrants performance of its components to the specifications applicable at the time of sale，in accordance with the warranty in Tl＇s terms and conditions of sale of semiconductor products．Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty．Except where mandated by applicable law，testing of all parameters of each component is not necessarily performed．
TI assumes no liability for applications assistance or the design of Buyers＇products．Buyers are responsible for their products and applications using TI components．To minimize the risks associated with Buyers＇products and applications，Buyers should provide adequate design and operating safeguards．
TI does not warrant or represent that any license，either express or implied，is granted under any patent right，copyright，mask work right，or other intellectual property right relating to any combination，machine，or process in which TI components or services are used．Information published by TI regarding third－party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof．Use of such information may require a license from a third party under the patents or other intellectual property of the third party，or a license from TI under the patents or other intellectual property of TI．
Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties，conditions，limitations，and notices． TI is not responsible or liable for such altered documentation．Information of third parties may be subject to additional restrictions．
Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice． TI is not responsible or liable for any such statements．
Buyer acknowledges and agrees that it is solely responsible for compliance with all legal，regulatory and safety－related requirements concerning its products，and any use of TI components in its applications，notwithstanding any applications－related information or support that may be provided by TI．Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures，monitor failures and their consequences，lessen the likelihood of failures that might cause harm and take appropriate remedial actions．Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety－critical applications．
In some cases，TI components may be promoted specifically to facilitate safety－related applications．With such components，Tl＇s goal is to help enable customers to design and create their own end－product solutions that meet applicable functional safety standards and requirements．Nonetheless，such components are subject to these terms．
No TI components are authorized for use in FDA Class III（or similar life－critical medical equipment）unless authorized officers of the parties have executed a special agreement specifically governing such use．
Only those TI components which TI has specifically designated as military grade or＂enhanced plastic＂are designed and intended for use in military／aerospace applications or environments．Buyer acknowledges and agrees that any military or aerospace use of TI components which have not been so designated is solely at the Buyer＇s risk，and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use．
TI has specifically designated certain components as meeting ISO／TS16949 requirements，mainly for automotive use．In any case of use of non－designated products，TI will not be responsible for any failure to meet ISO／TS16949．

| Products |  | Applications |  |
| :---: | :---: | :---: | :---: |
| Audio | www．ti．com／audio | Automotive and Transportation | www．ti．com／automotive |
| Amplifiers | amplifier．ti．com | Communications and Telecom | www．ti．com／communications |
| Data Converters | dataconverter．ti．com | Computers and Peripherals | www．ti．com／computers |
| DLP® Products | www．dlp．com | Consumer Electronics | www．ti．com／consumer－apps |
| DSP | dsp．ti．com | Energy and Lighting | www．ti．com／energy |
| Clocks and Timers | www．ti．com／clocks | Industrial | www．ti．com／industrial |
| Interface | interface．ti．com | Medical | www．ti．com／medical |
| Logic | logic．ti．com | Security | www．ti．com／security |
| Power Mgmt | power．ti．com | Space，Avionics and Defense | www．ti．com／space－avionics－defense |
| Microcontrollers | microcontroller．ti．com | Video and Imaging | www．ti．com／video |
| RFID | www．ti－rfid．com |  |  |
| OMAP Applications Processors | www．ti．com／omap | TI E2E Community | e2e．ti．com |
| Wireless Connectivity | www．ti．com／wirelessco |  |  |

